

Capsule Phase Control Thyristor

Consists of a diffused silicon element mounted in an hermetic ceramic cold welded capsule, and features an amplifying gate. Available in industry standard and thin housings.

Ratings	Unless otherwise indicated $T_j = 125^\circ\text{C}$	Maximum Limits						Units
		36	38	40	42	44	45	
	Voltage Codes							
V_{DRM}	Repetitive peak off-state voltage	3600	3800	4000	4200	4400	4500	V
V_{DSM}	Non-repetitive peak off-state voltage	3600	3800	4000	4200	4400	4500	V
V_{RRM}	Repetitive peak reverse voltage	3600	3800	4000	4200	4400	4500	V
V_{RSM}	Non-repetitive peak reverse voltage	3700	3900	4100	4300	4500	4600	V

$I_{\text{T(AV)}}$	Average on-state current	Half sine wave	$\left\{ \begin{array}{l} 55^\circ\text{C heatsink temperature} \\ \text{(double side cooled)} \\ 85^\circ\text{C heatsink temperature} \\ \text{(single side cooled)} \end{array} \right.$	880 385	A A
$I_{\text{T(RMS)}}$	R.M.S on-state current		25°C heatsink temperature, double side cooled	1725	A
I_{T}	Continuous on-state current		25°C heatsink temperature, double side cooled	1535	A
$I_{\text{TSM(1)}}$	Peak one-cycle surge		10ms duration, 60% V_{RRM} re-applied	7700	A
$I_{\text{TSM(2)}}$	Peak one-cycle surge		10ms duration, $V_{\text{R}} \leq 10$ volts	8470	A
$I^2 t_{(2)}$	Maximum permissible surge energy		10ms duration, $V_{\text{R}} \leq 10$ volts	359×10^3	$\text{A}^2 \text{s}$
			3ms duration, $V_{\text{R}} \leq 10$ volts	265×10^3	$\text{A}^2 \text{s}$
I_{FGM}	Peak forward gate current		Anode positive with respect to cathode	7.5	A
V_{FGM}	Peak forward gate voltage		Anode positive with respect to cathode	10	V
V_{RGM}	Peak reverse gate voltage			5	V
P_{G}	Average gate power			4	W
P_{GM}	Peak gate power		100µs pulse width	30	W
dv/dt	Rate of rise of off-state voltage		Linear to 80% V_{DRM} gate open-circuit	*200	V/µs
di/dt (1)	Rate of rise of on-state current (repetitive)		Gate drive 20 volts, 20 ohms with $t_r \leq 1\mu\text{s}$.	150	A/µs
di/dt (2)	Rate of rise of on-state current (non-repetitive)		Anode voltage $\leq 80\% V_{\text{DRM}}$	300	A/µs
T_j	Operating temperature range			-40 to +125	°C
T_{stg}	Storage temperature range			-40 to +150	°C

Characteristics		Unless otherwise indicated $T_j = 125^\circ\text{C}$		
V_{TM}	Peak on-state voltage	$I_{\text{TM}} = 1600 \text{ A}$	2.77	V
V_{O}	Forward conduction threshold voltage		0.92	V
r	Forward conduction slope resistance		1.30	mΩ
I_{DRM}	Repetitive peak off-state current	At V_{DRM}	100	mA
I_{RRM}	Repetitive peak reverse current	At V_{RRM}	100	mA
I_{GT}	Gate current required to fire all devices		300	mA
V_{GT}	Gate voltage required to fire all devices	At 25°C, $V_{\text{A}} = 6 \text{ V}$, $I_{\text{A}} = 2 \text{ A}$	3.0	V
I_{H}	Holding current		1.0	A
V_{GD}	Gate voltage which will not trigger any device		0.25	V
$R_{\text{th (j-hs)}}$	Thermal resistance, junction to heat sink	Double side cooled	0.024	KW
		Single side cooled	0.048	KW

Ordering Information (Please quote device code as explained below)

N320	• H	• •	* dv/dt Code for 80% V_{DRM}
Fixed Type Code	Outline Code Nominal Thickness CH - 26.8 DH - 21.0	Voltage Code (see ratings)	200V/µs - No Code 300V/µs - GOO 400V/µs - HOO 500V/µs - JOO 750V/µs - KOO 1000V/µs - LOO

Typical code: N320CH42LOO, 4200 V_{DRM} , 4200 V_{RRM} , 1000V/µs dv/dt to 80% V_{DRM} , Thick Housing

Figure 1. Dissipation/Sink Temperature v. Mean Current.

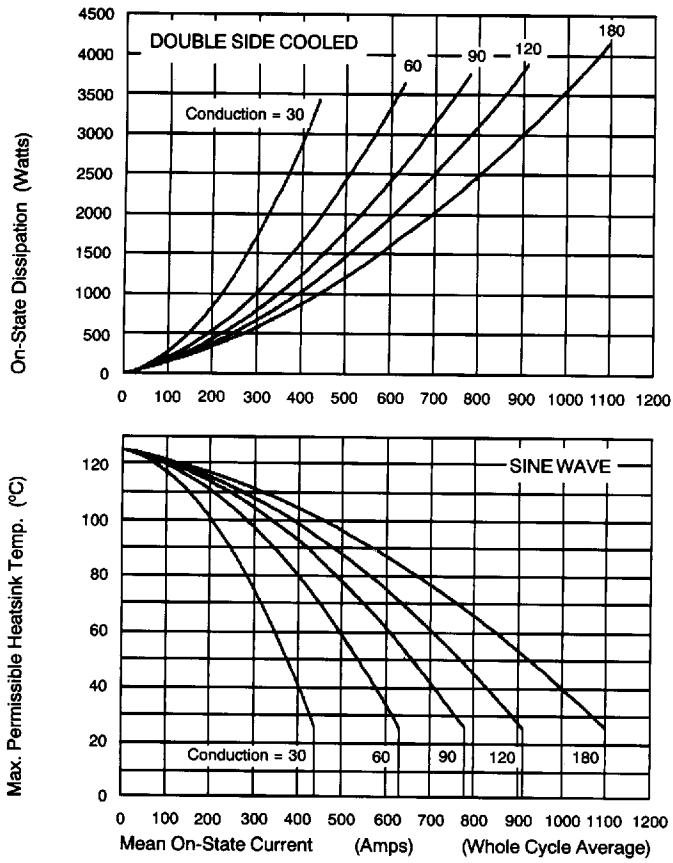


Figure 2. Dissipation/Sink Temperature v. Mean Current.

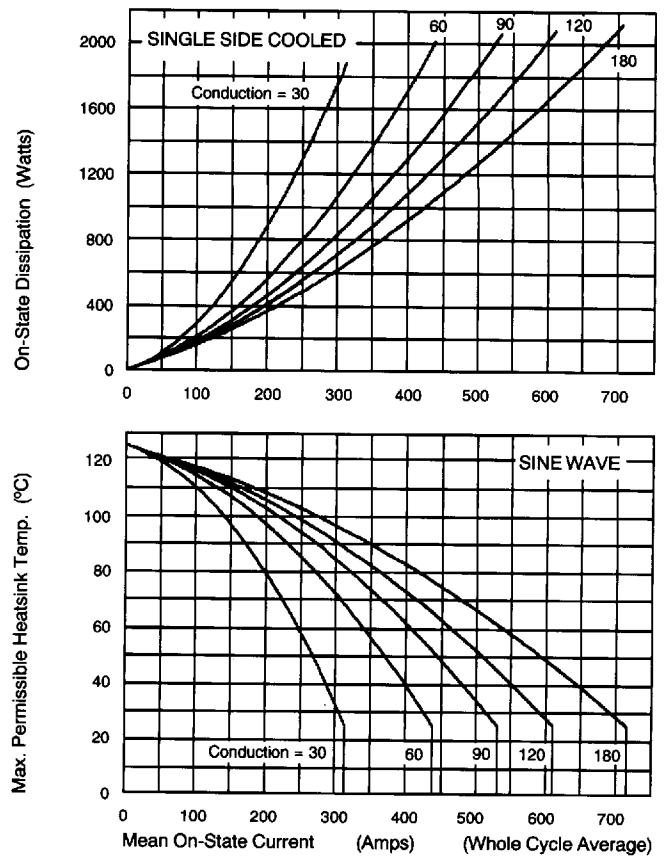


Figure 3. Junction to Sink Transient Thermal Impedance.

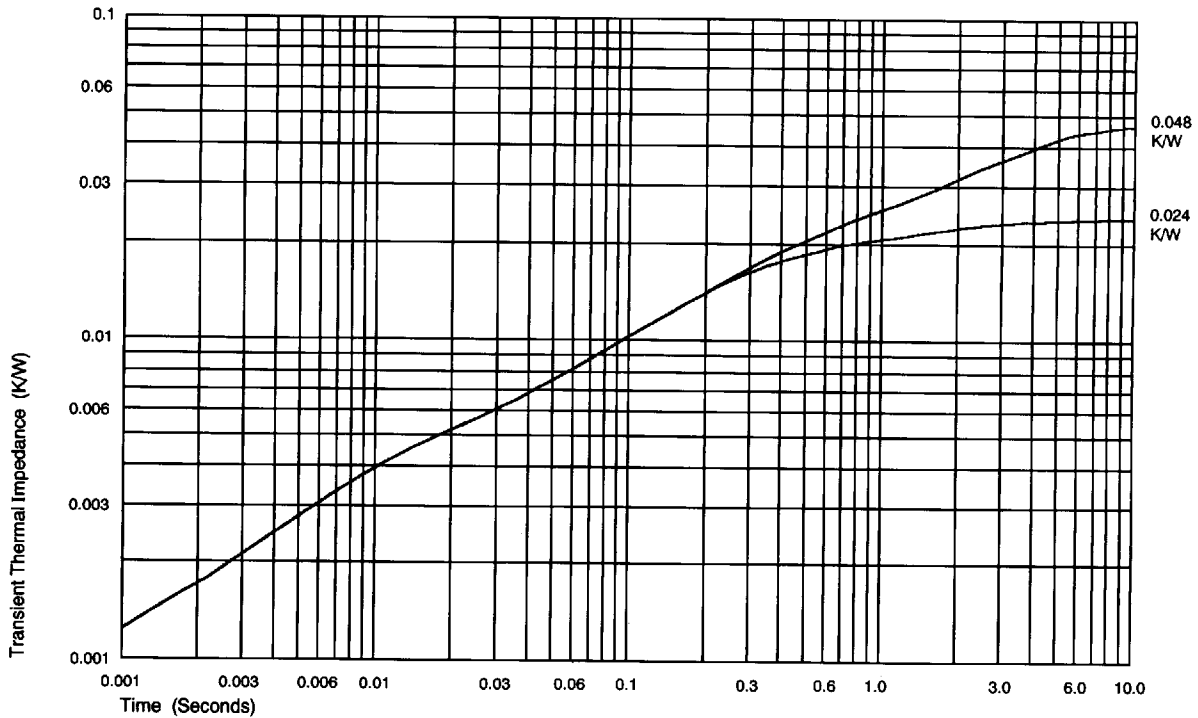


Figure 4. Dissipation/Sink Temperature v. Mean Current.

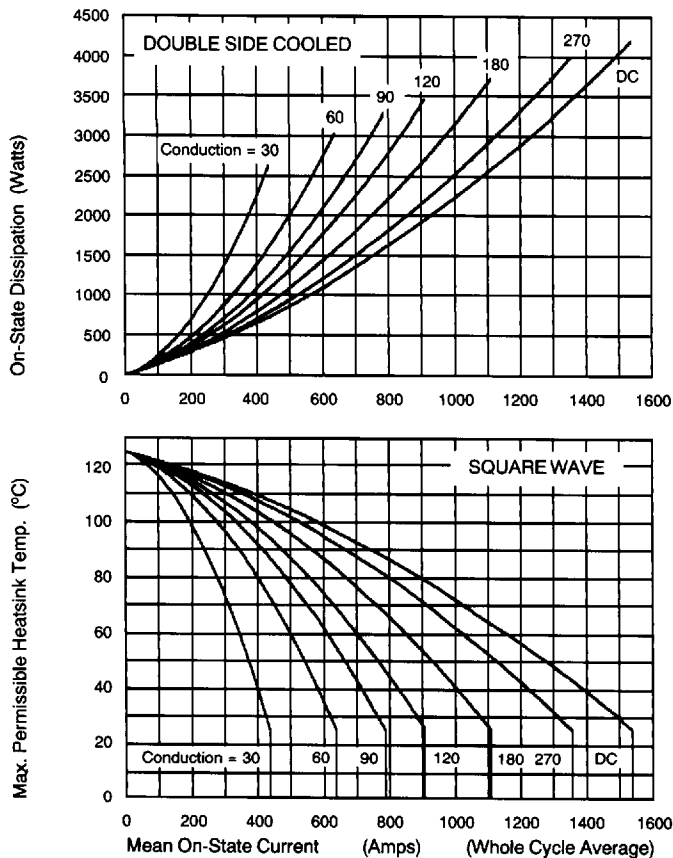


Figure 5. Dissipation/Sink Temperature v. Mean Current.

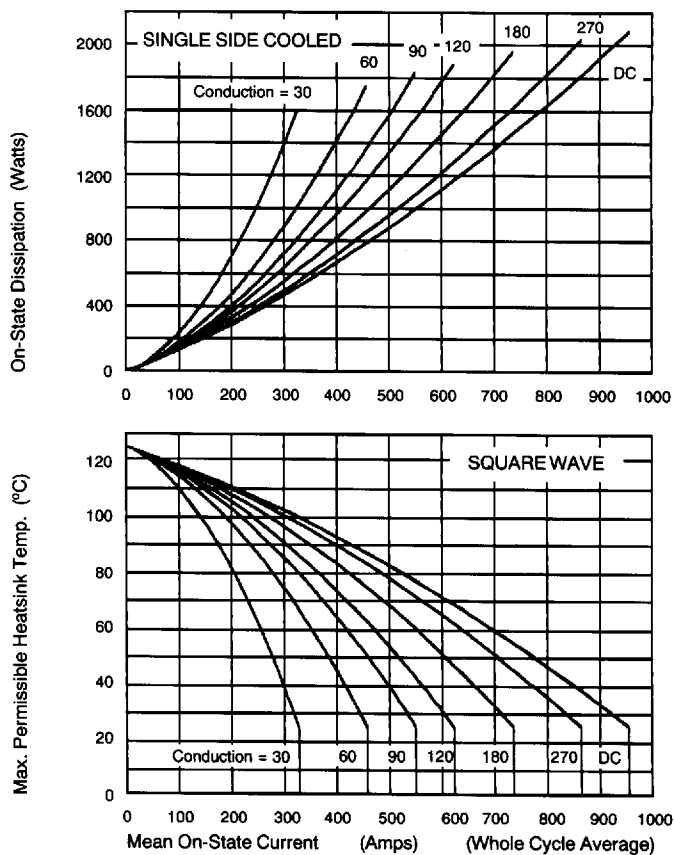


Figure 6. Non-Repetitive Surge Current at Initial Junction Temperature 125°C.

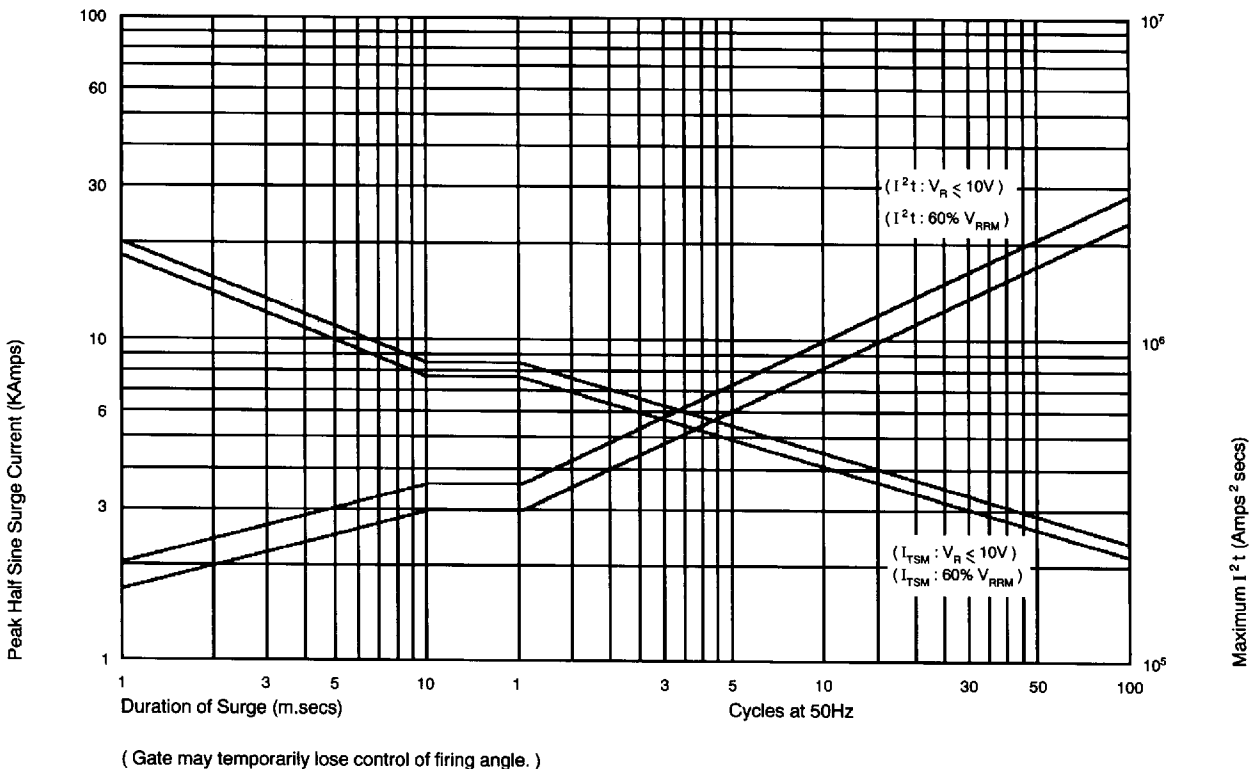


Figure 7. Gate Characteristics at 25°C Junction Temperature.

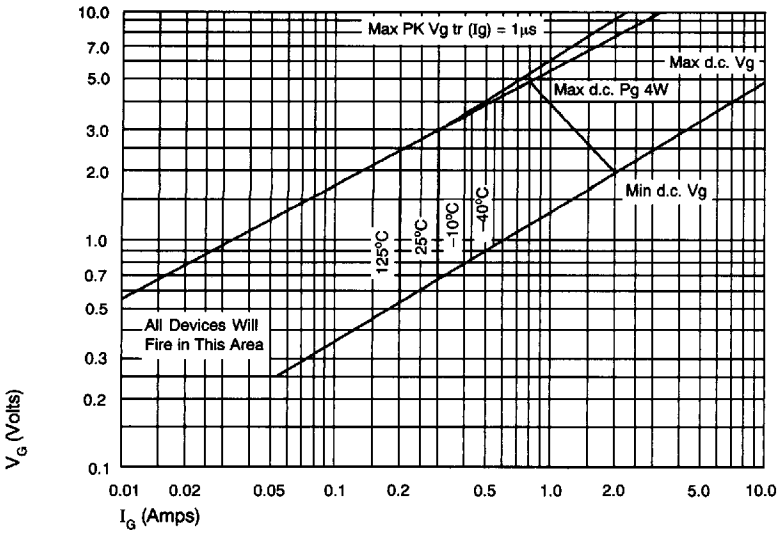
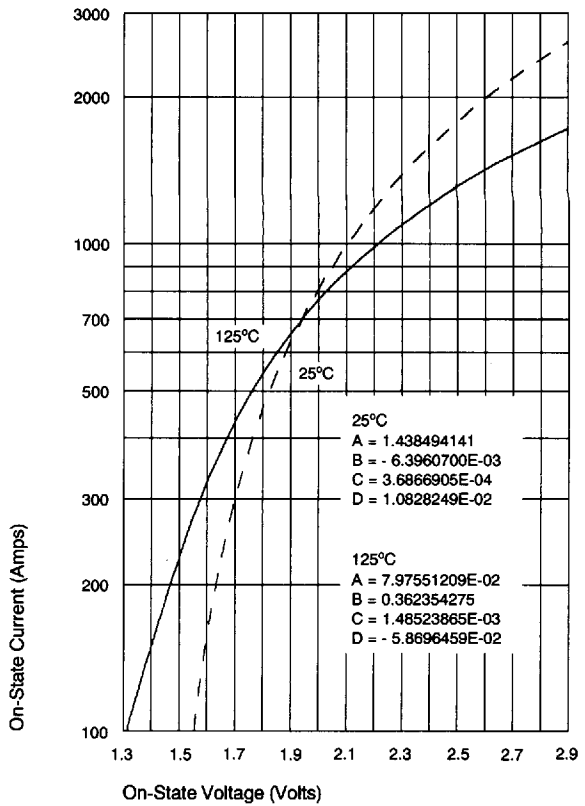
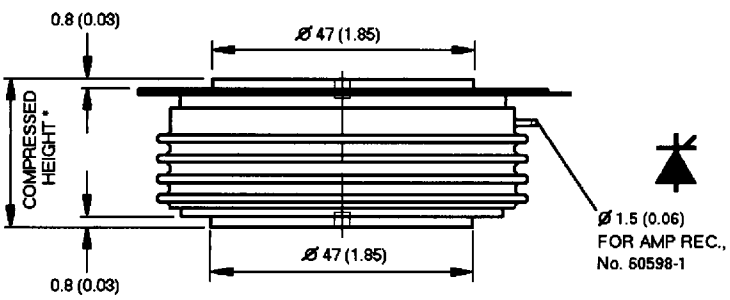
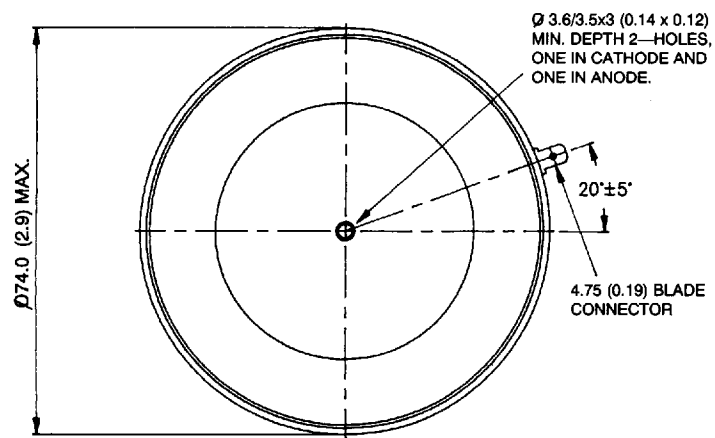


Figure 8. Peak On-State Characteristic at 125°C.



Forward Volt-Drop Calculations:
 $V_T = A + B \ln I_T + C I_T + D \sqrt{I_T}$

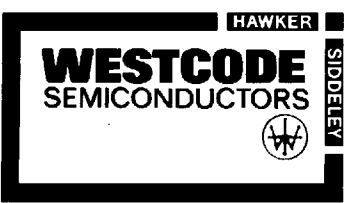
Notes:
 Dimensions in mm (inches)
 Mounting Force: 1900 – 2600 Kgf
 Weight: 510 grams



* For CH : 27.7/25.9 (1.09/1.02)
 DH : 21.0 ± 0.5 (0.83 ± 0.02)

Standard gate leads, 300mm long, available on request.

In the interest of product improvement, Westcode reserves the right to change specifications at any time without notice. © Westcode Semiconductors Ltd.



WESTCODE SEMICONDUCTORS LIMITED
 P.O. BOX 57, Chippenham, Wiltshire, England SN15 1JL
 Telephone (Sales) : (0249) 444524. Telex 44751.
 Telefax : (0249) 659448.

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